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OFFICE OF PP PLO FEORRDS	
TO THE HONORABLE DIRECTOR OF THE UNITED STAT	102023170EASE RECORD THE ATTACHED
Name of conveying party/ies): FILAPOLE SECTION	<ol><li>Name and address of receiving party(ies):</li></ol>
(a) Jae Hun Ku (b) Jae Hak Yee Additional name(s) of conveying party(ies) attached? □ Yes □ No	Name: Amkor Technology, Inc. Street Address: 1900 South Price Road City: Chandler AZ 85248-1604 Country: U.S.A.
3. Nature of Conveyance:	Name and address of receiving party(ies):
Assignment Merger Security Agreement Change of Name	Name: {Enter Name} Street Address: {Enter Street Address}
Other Execution Date: January 14, 2002	City: {City} State: {State} Zip: {Zip} Country: {Country} Additional name(s) & address(es) attached?
	🗋 Yes 🖾 No
<ul> <li>Application number(s) or patent number(s):</li> <li>If this document is being filed together with a new application</li> <li>A. Patent Application No.(s) – 09/816,599, filed March 23, 2001</li> </ul>	n, the execution date of the application is:
Title: Semiconductor Package Including Stacked Chips	
Additional r	numbers attached? Yes No
<ol> <li>Name and address of party to whom correspondence concerning document should be mailed:</li> </ol>	6. Total number of applications and patents involved: <u>1</u>
Name: James E. Parsons	-
Internal Address: SKJERVEN MORRILL MacPHERSON LLP	-
Street Address: <u>25 METRO DRIVE, SUITE 700</u> City <u>SAN JOSE</u> State <u>CA</u> Zip <u>95110</u>	<ul> <li>Total fee (37 CFR 3.41): \$40.00</li> <li>Authorized to be charged to Deposit Account t9-2386</li> <li>Charge Deposit Account 19-2386 for any additional fee required for this conveyance and credit deposit account 19-2386 any amounts overpaid</li> </ul>
DO NOT U	SE THIS SPACE
	SE THIS SPACE
8. Statement and signature. To the best of my knowledge and belief, the foregoing informoriginal document.	SE THIS SPACE
<ol> <li>8. Statement and signature.</li> <li>To the best of my knowledge and belief, the foregoing informoriginal document.</li> <li>James E. Parsons 34,691</li> <li>Name of Person Signing</li> </ol>	SE THIS SPACE
8. Statement and signature. To the best of my knowledge and belief, the foregoing infor- original document. James E. Parsons 34,691 Name of Person Signing	SE THIS SPACE
8. Statement and signature. To the best of my knowledge and belief, the foregoing informoriginal document. James E. Parsons 34,691 Name of Person Signing 4. 844887 03/19/2002 LMUELLER 00000199 192386 09816599	SE THIS SPACE mation is true and correct and any attached copy is a true copy of the 5 Reason 2/19/02
<ul> <li>8. Statement and signature.</li> <li>To the best of my knowledge and belief, the foregoing informoriginal document.</li> <li>James E. Parsons 34,691</li> <li>Name of Person Signing</li> <li>Katelen A. Statement and signature.</li> </ul>	SE THIS SPACE

REEL: 012680 FRAME: 0312

## ASSIGNMENT

For good and valuable consideration, receipt of which is hereby acknowledged, we

Seong Min Seo	of	Seoul, Republic of Korea
Young Suk Chung	of	Seoul, Republic of Korea
Jong Sik Paek	of	Seoul, Republic of Korea
Jae Hun Ku	of	Singapore
Jae Hak Yee	of	Singapore

hereby sell, assign and transfer to Amkor Technology, Inc., a Delaware corporation, having a place of business at 1900 South Price Road, Chanlder, AZ 85248-1604, its successors and assigns, the entire right, title and interest throughout the world in our invention in

Semiconductor Package Including Stacked Chips

for which we filed a United States Patent Application on March 23, 2001, which now has Serial No. 09/816,599, and all patent applications and patents of every country for said invention, including divisions, reissues, continuations and extensions thereof, and all rights of priority resulting from the filing of said applications; we authorize the above-named assignee to apply for patents of foreign countries for said invention, and to claim all rights of priority without further authorization from us; we agree to execute all papers useful in connection with said United States and foreign applications, and generally to do everything possible to aid said assignee, their successors, assigns and nominees, at their request and expense, in obtaining and enforcing patents for said invention in all countries; and we request that the United States Patent and Trademark Office issue all patents granted for said invention to the above-named assignee, its successors and assigns.

Executed this \_\_\_\_\_ day of \_\_\_\_\_, 2001.

Seong Min Seo

WITNESSED:

Signature

Date

Type or print name of witness

, 2001.
Young Suk Chung
, 2001.
Jong Sik Paek
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Jae Hun Ku
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